You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Notes:

- ESD sensitive: ESD precautions shall be observed.
- Parts must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
Isolated power supply and Signal Isolation

Isolated from IO controller
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